AtOMS

Optical metrology tool for real-time monitoring and control of vacuum thin film deposition processes and dry etching

Atomic Optical Monitoring System

- VERSATILE INSTALLATION FOR PVD CHAMBERS
- FIBER OPTIC BASED MEASUREMENT SYSTEM

 Completely fiber optics-based solutions enables the use of switches that rapidly change system config. to allow accurate data processing
- BROAD SPECTRUM DETECTOR
 Allows for a single detector to be used for rapid element detection
- ELEMENTAL SELECTIVITY
 Leads to precis multi-element composition monitoring
- 3 PROBE CHANNELS
 Monitor multiple locations to view variations across systems



What are the Benefits?

- It pays for itself in 1-4 months depending on the process
- It can substantially increase profit margins
- it can save millions a year
- It results in a higher quality more predictable product



Applications

VACUUM PROCESSES

- Physical Vapor Deposition
- Magnetron Sputtering
- Ion Beam Sputtering
- Electron Beam Evaporation
- Thermal Evaporation
- Molecular Beam Epitaxy
- Plasma Etching

COATING TYPES

- Complex Multilayer & Thin Film Structures
- Extremely Thin Multilayers
- Coatings with Engineered Interface Layers
- Thin Films and Structures with Gradient Bandgap Profiles
- Multi-Element Coating
- Alloys & Compounds

Features

- over 80 + single elements and multi-element light sources enable element selectivity
- co-deposition: each element can be monitored individually
- measure independent of substrate shape, orientation and motion
- configure up to 3 probing beams in a single AtOMS system
- suitable for both deposition and etch processes
- measures process from within chamber
- measures only the region where the process is occurring
- installation on chambers with minimal retrofitting
- configure in multi bounce geometry for even greater sensitivity
- increasing validation of new elements as more research is developed

Competitive Advantages

Capability	AtOMS	Optical Monitoring	Crystal Monitor
Simultaneous multi-element deposition rate monitoring	√	✓	√
Element concentration of multi-element depositions	1	X	X
Monitoring of multi-element chemical composition	1	✓	X
>60 different chemical elements can be uniquely monitored	\checkmark	X	X
Monitoring extremely thin films (<3 nm)	√	X	1
Monitoring very high deposition rates	1	X	1
Deposition rate accuracy of 0.005 Å/sec	1	X	X
Film composition accuracy of 0.1 at.%	1	X	X
Monitoring Optically Opaque Materials, Metals and Alloys	1	X	√



